

SML10SIC03NC

SMD1 (TO-276AB) PACKAGE

SIC SCHOTTKY DIODE



 $V_R 300V$ $I_F 2x10A$

Semelab's Silicon Carbide (SiC) Schottky diodes exhibit low forward voltage, zero reverse recovery, and superb high-temperature performance.

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The devices employ Semelab's proven hermetic packaging technology and are suitable for high-frequency hard-switching applications, where system efficiency and reliability are paramount.

ABSOLUTE MAXIMUM RATINGS at T_J = 25 °C unless otherwise stated (per leg)

Symbol	Parameter	Rating	Units
V_R	DC Reverse Voltage	300	V
V_{RRM}	Repetitive Peak Reverse Voltage	300	V
V _{RSM}	Surge Peak Reverse Voltage	300	V
I _F	DC Forward Current T _C = 100 °C	10	Α
I _{FRM}	Repetitive Peak Forward Current $T_J = 150 ^{\circ}\text{C}$, $T_C = 100 ^{\circ}\text{C}$, $D = 0.1$	45	Α
I _{FSM}	Surge Peak Forward Current T _C = 25 °C, tp = 10µs	100	Α
P_D	Power Dissipation $T_C = 25^{\circ}C$	70W	W
T_J, T_{stq}	Operating Junction and Storage Temperature	-55 to +175	℃

Semelab Plc reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by Semelab is believed to be both accurate and reliable at the time of going to press. However Semelab assumes no responsibility for any errors or omissions discovered in its use. Semelab encourages customers to verify that datasheets are current before placing orders.



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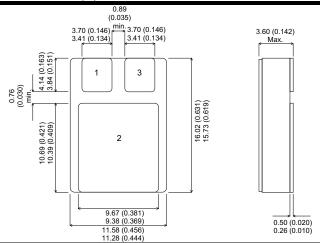
ELECTRICAL CHARACTERISTICS at T_J = 25 °C unless otherwise stated (per leg)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units				
Static Characteristics										
V _F	Forward Voltage	I _F = 10A		1.5	1.7	V				
		I _F = 10A, T _J = 150 ℃		1.5	1.9	V				
I _R	Reverse Current	$V_{R} = 300V$		15	200	μΑ				
		V _R = 300V, T _J = 150 ℃		20	1000	μΑ				
Dynamic Characteristics										
Q_c	Total Capacitive Charge	$V_R = 200V, I_F = 10A,$		23		nC				
t _{rr}	Reverse Recovery Time	di/dt = 200A/μs, T _J = 150 ℃		n.a.		ns				
С	Total Capacitance	$V_R = 0V$, $f = 1MHz$		600		рF				
		$V_R = 150V, f = 1MHz$		55		рF				
		$V_R = 300V, f = 1MHz$		40		рF				

THERMAL CHARACTERISTICS (per leg)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
R _{th}	Thermal Resistance,	TO276AB Package		2.1		°C/W
	Junction to Case					

PACKAGE DIMENSIONS mm (in)



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